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What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Obsolete
Core Processor	Z8
Core Size	8-Bit
Speed	8MHz
Connectivity	-
Peripherals	HLVD, POR, WDT
Number of I/O	32
Program Memory Size	4KB (4K x 8)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	237 x 8
Voltage - Supply (Vcc/Vdd)	2V ~ 3.6V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	-40°C ~ 105°C (TA)
Mounting Type	Surface Mount
Package / Case	48-BSSOP (0.295", 7.50mm Width)
Supplier Device Package	-
Purchase URL	https://www.e-xfl.com/product-detail/zilog/zgp323leh4804c

Table 5. 40- and 48-Pin Configuration (Continued)

40-Pin PDIP/CDIP* #	48-Pin SSOP #	Symbol
33	40	P13
8	9	P14
9	10	P15
12	15	P16
13	16	P17
35	42	P20
36	43	P21
37	44	P22
38	45	P23
39	46	P24
2	2	P25
3	3	P26
4	4	P27
16	19	P31
17	20	P32
18	21	P33
19	22	P34
22	26	P35
24	28	P36
23	27	P37
20	23	NC
40	47	NC
1	1	NC
21	25	$\overline{\text{RESET}}$
15	18	XTAL1
14	17	XTAL2
11	12, 13	V_{DD}
31	24, 37, 38	V_{SS}
25	29	Pref1/P30
	48	NC

Absolute Maximum Ratings

Stresses greater than those listed in Table 7 might cause permanent damage to the device. This rating is a stress rating only. Functional operation of the device at any condition above those indicated in the operational sections of these specifications is not implied. Exposure to absolute maximum rating conditions for an extended period might affect device reliability.

Table 6. Absolute Maximum Ratings

Parameter	Minimum	Maximum	Units	Notes
Ambient temperature under bias	0	+70	C	
Storage temperature	–65	+150	C	
Voltage on any pin with respect to V_{SS}	–0.3	+5.5	V	1
Voltage on V_{DD} pin with respect to V_{SS}	–0.3	+3.6	V	
Maximum current on input and/or inactive output pin	–5	+5	µA	
Maximum output current from active output pin	–25	+25	mA	
Maximum current into V_{DD} or out of V_{SS}		75	mA	

Notes:
This voltage applies to all pins except the following: V_{DD}, P32, P33 and $\overline{\text{RESET}}$.

Standard Test Conditions

The characteristics listed in this product specification apply for standard test conditions as noted. All voltages are referenced to GND. Positive current flows into the referenced pin (see Figure 7).

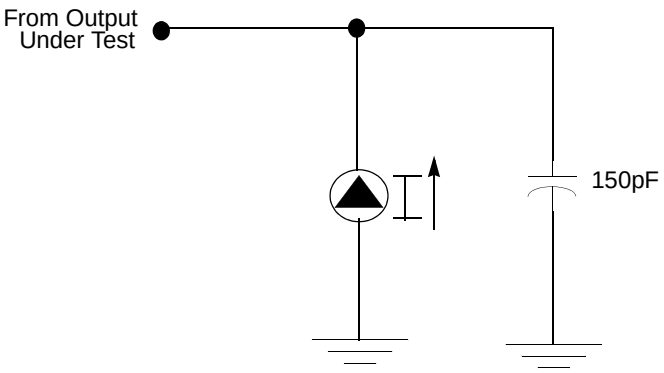


Figure 7. Test Load Diagram

Capacitance

Table 7 lists the capacitances.

Table 7. Capacitance

Parameter	Maximum
Input capacitance	12pF
Output capacitance	12pF
I/O capacitance	12pF
Note: T_A = 25° C, V_{CC} = GND = 0 V, f = 1.0 MHz, unmeasured pins returned to GND	

DC Characteristics

Table 8. DC Characteristics

			T_A= 0°C to +70°C					
Symbol	**Parameter**	**V_{CC}**	**Min**	**Typ**	**Max**	**Units**	**Conditions**	**Notes**
V_{CC}	Supply Voltage		2.0		3.6	V	See Note 5	5
V_{CH}	Clock Input High Voltage	2.0-3.6	0.8		V_{CC}+0.3	V	Driven by External Clock Generator	
V_{CL}	Clock Input Low Voltage	2.0-3.6	V_{SS}–0.3		0.5	V	Driven by External Clock Generator	
V_{IH}	Input High Voltage	2.0-3.6	0.7 V_{CC}		V_{CC}+0.3	V		
V_{IL}	Input Low Voltage	2.0-3.6	V_{SS}–0.3		0.2 V_{CC}	V		
V_{OH1}	Output High Voltage	2.0-3.6	V_{CC}–0.4			V	I_{OH} = –0.5mA	
V_{OH2}	Output High Voltage (P36, P37, P00, P01)	2.0-3.6	V_{CC}–0.8			V	I_{OH} = –7mA	
V_{OL1}	Output Low Voltage	2.0-3.6			0.4	V	I_{OL} = 1.0mA I_{OL} = 4.0mA	
V_{OL2}	Output Low Voltage (P00, P01, P36, P37)	2.0-3.6			0.8	V	I_{OL} = 10mA	
V_{OFFSET}	Comparator Input Offset Voltage	2.0-3.6			25	mV		
V_{REF}	Comparator Reference Voltage	2.0-3.6	0		V_{DD} -1.75	V		
I_{IL}	Input Leakage	2.0-3.6	–1		1	µA	V_{IN} = 0V, V_{CC} Pull-ups disabled	
I_{OL}	Output Leakage	2.0-3.6	–1		1	µA	V_{IN} = 0V, V_{CC}	
I_{CC}	Supply Current	2.0 3.6			10 15	mA mA	at 8.0 MHz at 8.0 MHz	1, 2 1, 2

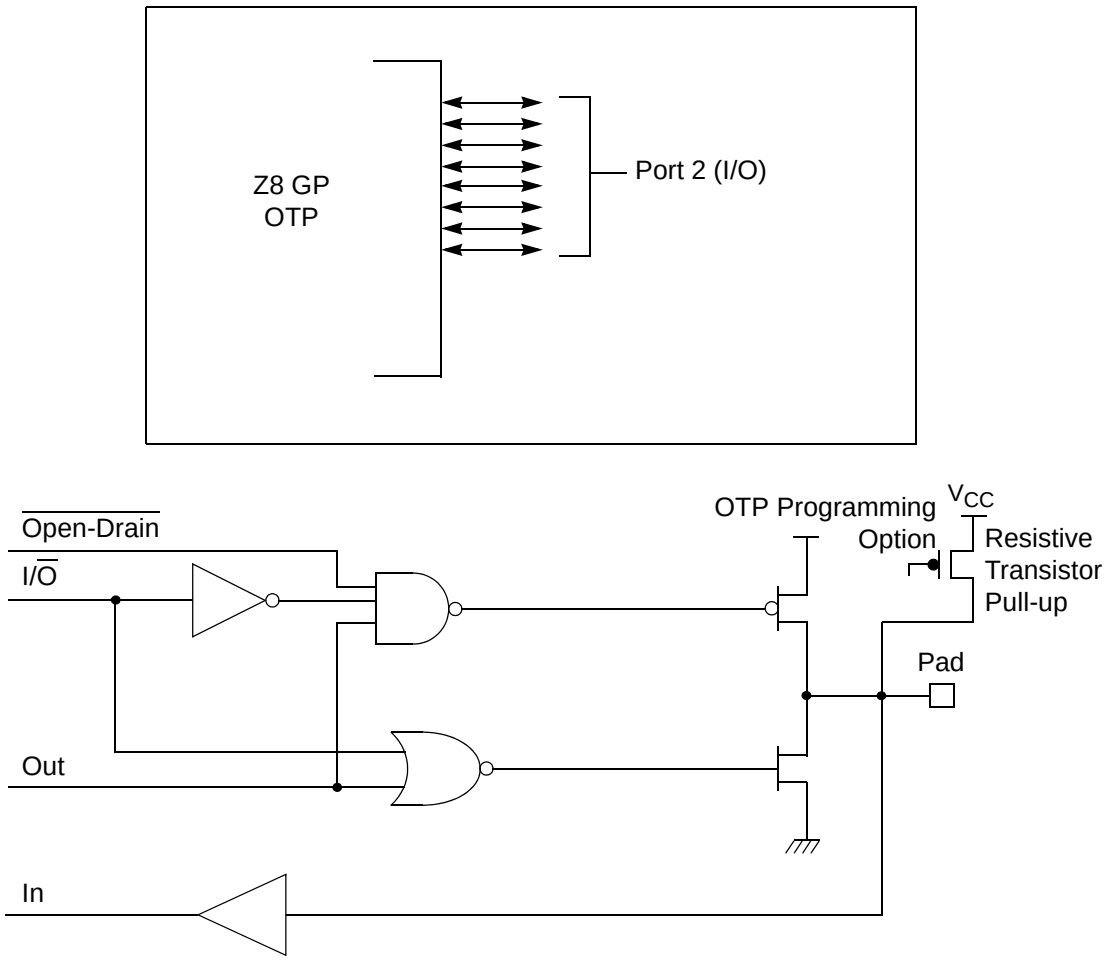


Figure 11. Port 2 Configuration

Port 3 (P37–P30)

Port 3 is a 8-bit, CMOS-compatible fixed I/O port (see Figure 12). Port 3 consists of four fixed input (P33–P30) and four fixed output (P37–P34), which can be configured under software control for interrupt and as output from the counter/timers. P30, P31, P32, and P33 are standard CMOS inputs; P34, P35, P36, and P37 are push-pull outputs.

Comparator Inputs

In analog mode, P31 and P32 have a comparator front end. The comparator reference is supplied to P33 and Pref1. In this mode, the P33 internal data latch and its corresponding IRQ1 are diverted to the SMR sources (excluding P31, P32, and P33) as indicated in Figure 12 on page 20. In digital mode, P33 is used as D3 of the Port 3 input register, which then generates IRQ1.

Note: Comparators are powered down by entering Stop Mode. For P31–P33 to be used in a Stop Mode Recovery source, these inputs must be placed into digital mode.

Comparator Outputs

These channels can be programmed to be output on P34 and P37 through the PCON register.

$\overline{\text{RESET}}$ (Input, Active Low)

Reset initializes the MCU and is accomplished either through Power-On, Watch-Dog Timer, Stop Mode Recovery, Low-Voltage detection, or external reset. During Power-On Reset and Watch-Dog Timer Reset, the internally generated reset drives the reset pin Low for the POR time. Any devices driving the external reset line must be open-drain to avoid damage from a possible conflict during reset conditions. Pull-up is provided internally.

When the Z8 GP™ asserts (Low) the $\overline{\text{RESET}}$ pin, the internal pull-up is disabled. The Z8 GP™ does not assert the $\overline{\text{RESET}}$ pin when under VBO.

Note: The external Reset does not initiate an exit from STOP mode.

Functional Description

This device incorporates special functions to enhance the Z8®, functionality in consumer and battery-operated applications.

Program Memory

This device addresses up to 32KB of OTP memory. The first 12 Bytes are reserved for interrupt vectors. These locations contain the six 16-bit vectors that correspond to the six available interrupts.

RAM

This device features 256B of RAM. See Figure 14.

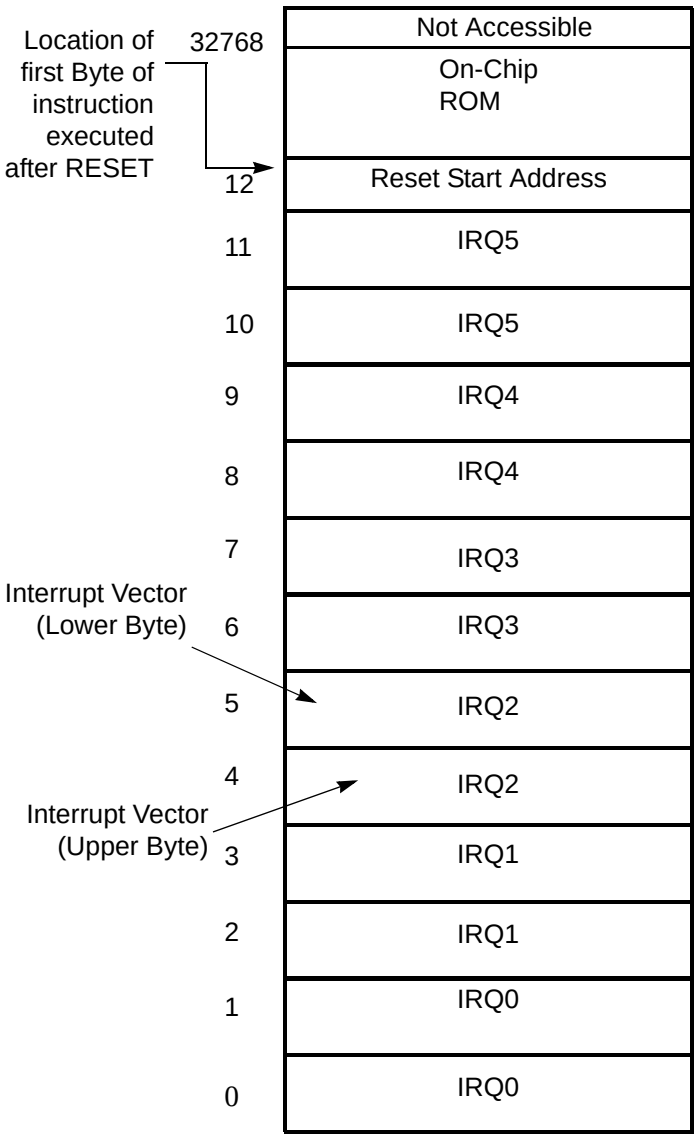


Figure 14. Program Memory Map (32K OTP)

Expanded Register File

The register file has been expanded to allow for additional system control registers and for mapping of additional peripheral devices into the register address area. The Z8® register address space (R0 through R15) has been implemented as 16 banks, with 16 registers per bank. These register groups are known as the

Table 14. CTR2(D)02H: Counter/Timer16 Control Register

Field	Bit Position		Value	Description
T16_Enable	7-------	R	0*	Counter Disabled
			1	Counter Enabled
		W	0	Stop Counter
			1	Enable Counter
Single/Modulo-N	-6------	R/W		Transmit Mode
			0*	Modulo-N
			1	Single Pass Demodulation Mode
			0	T16 Recognizes Edge
			1	T16 Does Not Recognize Edge
Time_Out	--5-----	R	0*	No Counter Timeout
			1	Counter Timeout Occurred
		W	0	No Effect
			1	Reset Flag to 0
T16 _Clock	---43---	R/W	00**	SCLK
			01	SCLK/2
			10	SCLK/4
			11	SCLK/8
Capture_INT_Mask	-----2--	R/W	0**	Disable Data Capture Int.
			1	Enable Data Capture Int.
Counter_INT_Mask	------1-	R/W	0	Disable Timeout Int.
			1	Enable Timeout Int.
P35_Out	-------0	R/W	0*	P35 as Port Output
			1	T16 Output on P35

Note:
*Indicates the value upon Power-On Reset.
**Indicates the value upon Power-On Reset.Not reset with Stop Mode recovery.

T16_Enable

This field enables T16 when set to 1.

Single/Modulo-N

In TRANSMIT Mode, when set to 0, the counter reloads the initial value when it reaches the terminal count. When set to 1, the counter stops when the terminal count is reached.

Table 15. CTR3 (D)03H: T8/T16 Control Register (Continued)

Field	Bit Position		Value	Description
Reserved	---43210	R	1	Always reads 11111
		W	x	No Effect

Note: *Indicates the value upon Power-On Reset.
**Indicates the value upon Power-On Reset. Not reset with Stop Mode recovery.

Counter/Timer Functional Blocks

Input Circuit

The edge detector monitors the input signal on P31 or P20. Based on CTR1 D5–D4, a pulse is generated at the Pos Edge or Neg Edge line when an edge is detected. Glitches in the input signal that have a width less than specified (CTR1 D3, D2) are filtered out (see Figure 18).

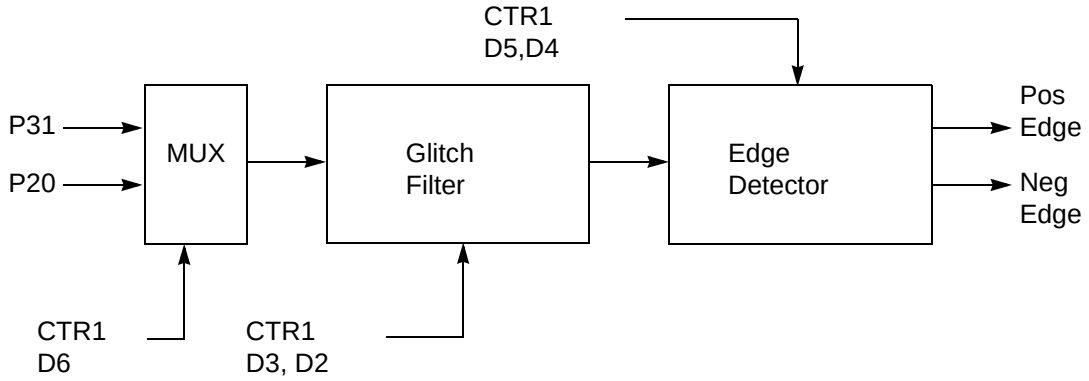


Figure 18. Glitch Filter Circuitry

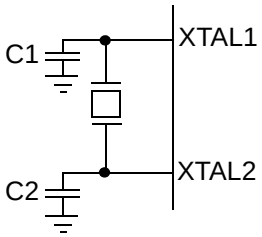
T8 Transmit Mode

Before T8 is enabled, the output of T8 depends on CTR1, D1. If it is 0, T8_OUT is 1; if it is 1, T8_OUT is 0. See Figure 19.

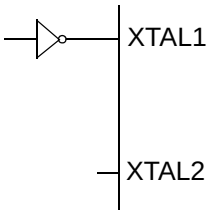
Clock

The device's on-chip oscillator has a high-gain, parallel-resonant amplifier, for connection to a crystal, ceramic resonator, or any suitable external clock source (XTAL1 = Input, XTAL2 = Output). The crystal must be AT cut, 1 MHz to 8 MHz maximum, with a series resistance (RS) less than or equal to 100 Ω. The on-chip oscillator can be driven with a suitable external clock source.

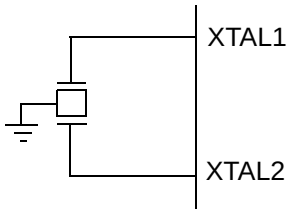
The crystal must be connected across XTAL1 and XTAL2 using the recommended capacitors (capacitance greater than or equal to 22 pF) from each pin to ground.



Crystal
C1, C2 = 33pF TYP *
f = 8 MHz



External Clock



Ceramic Resonator f = 8MHz

* Preliminary value including pin parasitics

Figure 31. Oscillator Configuration

Port 0 Output Mode (D2)

Bit 2 controls the output mode of port 0. A 1 in this location sets the output to push-pull, and a 0 sets the output to open-drain.

Stop-Mode Recovery Register (SMR)

This register selects the clock divide value and determines the mode of Stop Mode Recovery (Figure 33). All bits are write only except bit 7, which is read only. Bit 7 is a flag bit that is hardware set on the condition of Stop recovery and reset by a power-on cycle. Bit 6 controls whether a low level or a high level at the XOR-gate input (Figure 35 on page 57) is required from the recovery source. Bit 5 controls the reset delay after recovery. Bits D2, D3, and D4 of the SMR register specify the source of the Stop Mode Recovery signal. Bits D0 determines if SCLK/TCLK are divided by 16 or not. The SMR is located in Bank F of the Expanded Register Group at address 0BH.

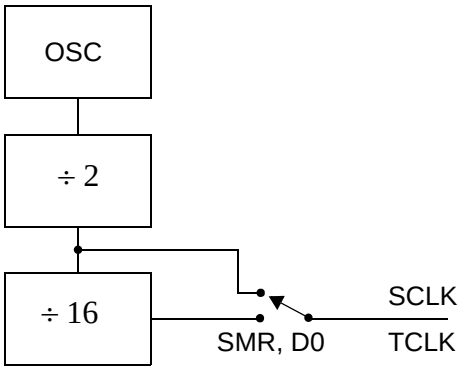


Figure 34. SCLK Circuit

Stop-Mode Recovery Source (D2, D3, and D4)

These three bits of the SMR specify the wake-up source of the Stop recovery (Figure 35 and Table 19).

Stop-Mode Recovery Register 2—SMR2(F)0DH

Table 18 lists and briefly describes the fields for this register.

Table 18. SMR2(F)0DH:Stop Mode Recovery Register 2*

Field	Bit Position		Value	Description
Reserved	7-------		0	Reserved (Must be 0)
Recovery Level	-6------	W	0† 1	Low High
Reserved	--5-----		0	Reserved (Must be 0)
Source	---432--	W	000† 001 010 011 100 101 110 111	A. POR Only B. NAND of P23–P20 C. NAND of P27–P20 D. NOR of P33–P31 E. NAND of P33–P31 F. NOR of P33–P31, P00, P07 G. NAND of P33–P31, P00, P07 H. NAND of P33–P31, P22–P20
Reserved	------10		00	Reserved (Must be 0)

Notes:
* Port pins configured as outputs are ignored as a SMR recovery source.
† Indicates the value upon Power-On Reset

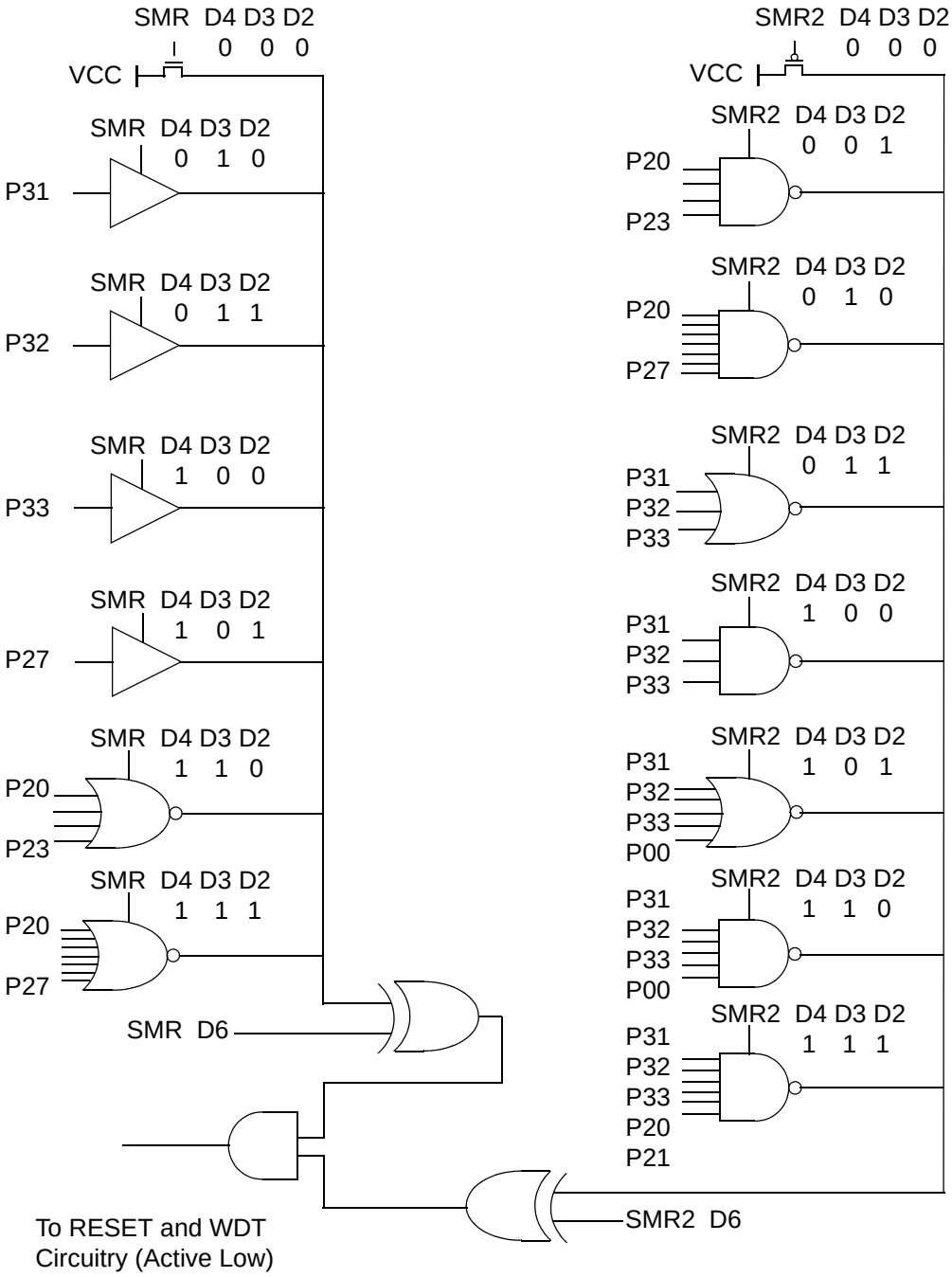


Figure 35. Stop Mode Recovery Source

CTR1(0D)01H

D7	D6	D5	D4	D3	D2	D1	D0

Transmit Mode*
R/W 0 T16_OUT is 0 initially*
1 T16_OUT is 1 initially

Demodulation Mode
R 0 No Falling Edge Detection
R 1 Falling Edge Detection

W 0 No Effect
W 1 Reset Flag to 0

Transmit Mode*
R/W 0 T8_OUT is 0 initially*
1 T8_OUT is 1 initially

Demodulation Mode
R 0 No Rising Edge Detection
R 1 Rising Edge Detection

W 0 No Effect
W 1 Reset Flag to 0

Transmit Mode*
0 0 Normal Operation*
0 1 Ping-Pong Mode
1 0 T16_OUT = 0
1 1 T16_OUT = 1

Demodulation Mode
0 0 No Filter
0 1 4 SCLK Cycle Filter
1 0 8 SCLK Cycle Filter
1 1 Reserved

Transmit Mode/T8/T16 Logic
0 0 AND**
0 1 OR
1 0 NOR
1 1 NAND

Demodulation Mode
0 0 Falling Edge Detection
0 1 Rising Edge Detection
1 0 Both Edge Detection
1 1 Reserved

Transmit Mode
0 P36 as Port Output *
1 P36 as T8/T16_OUT

Demodulation Mode
0 P31 as Demodulator Input
1 P20 as Demodulator Input

Transmit/Demodulation Mode
0 Transmit Mode *
1 Demodulation Mode

* Default setting after reset
**Default setting after reset. Not reset with Stop Mode recovery

Figure 40. T8 and T16 Common Control Functions ((0D)01H: Read/Write)

R249 IPR(F9H)

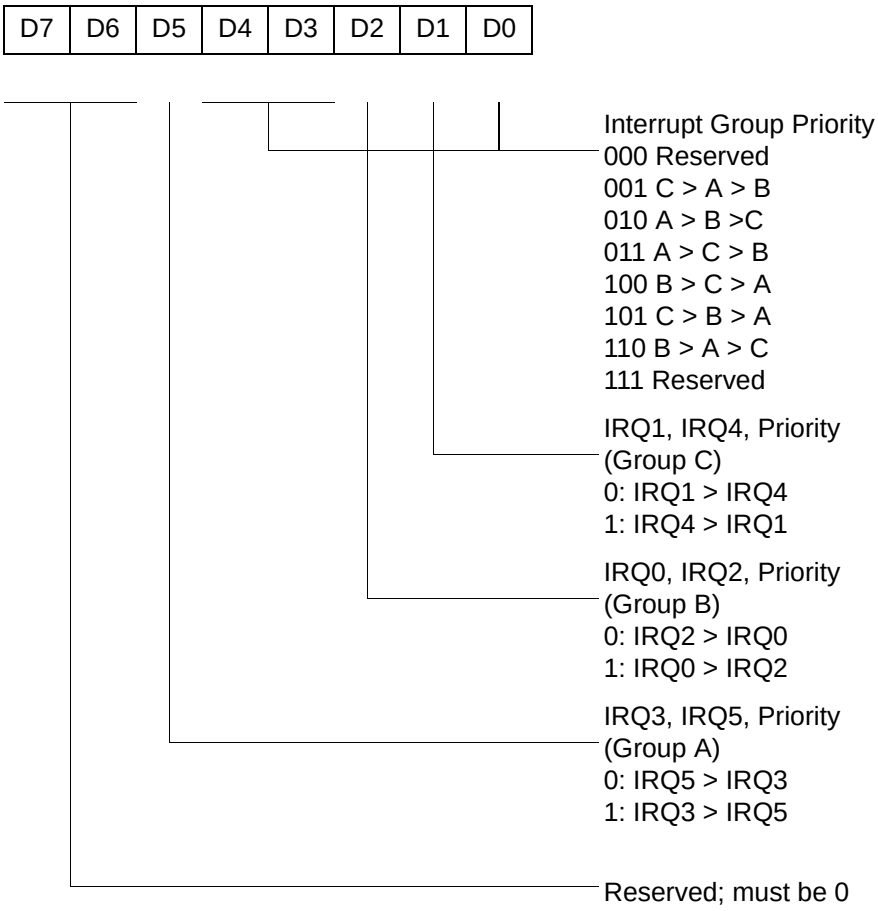


Figure 51. Interrupt Priority Register (F9H: Write Only)

R254 SPH(FEH)

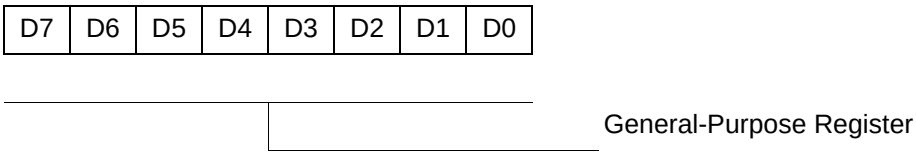


Figure 56. Stack Pointer High (FEH: Read/Write)

R255 SPL(FFH)

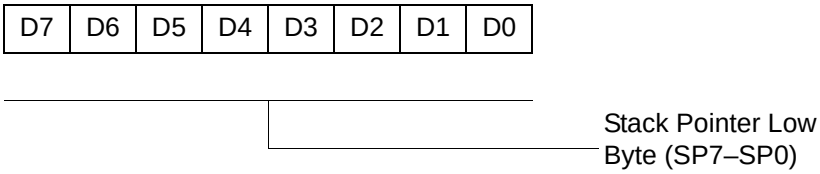


Figure 57. Stack Pointer Low (FFH: Read/Write)

Package Information

Package information for all versions of Z8 GP™ OTP MCU Family are depicted in Figures 58 through Figure 68.

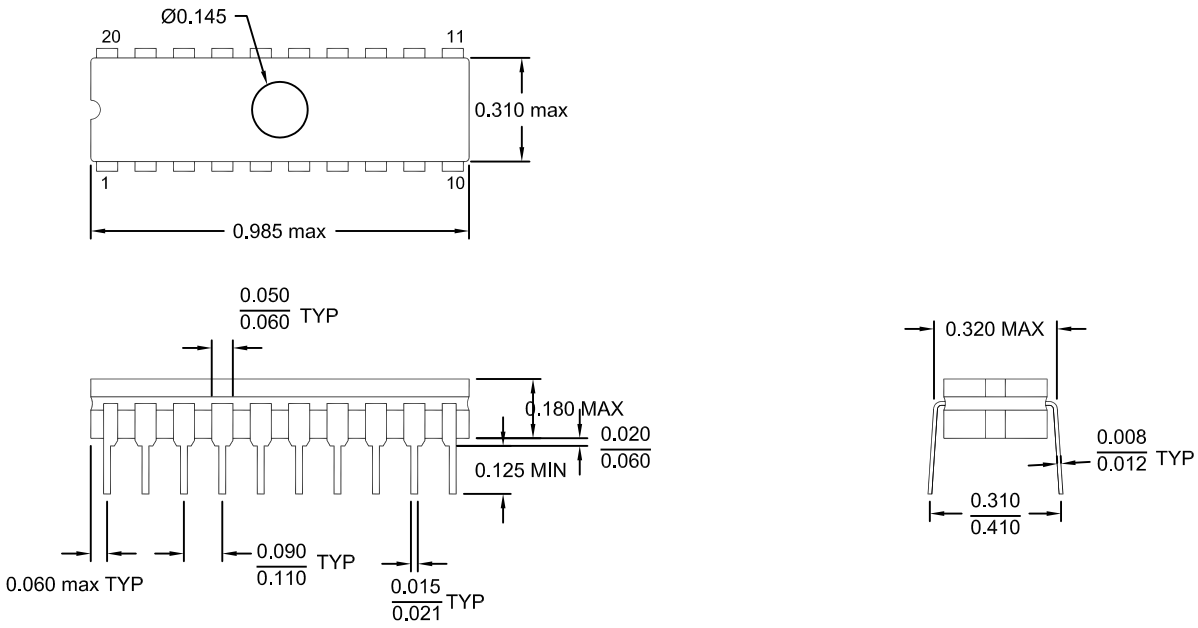


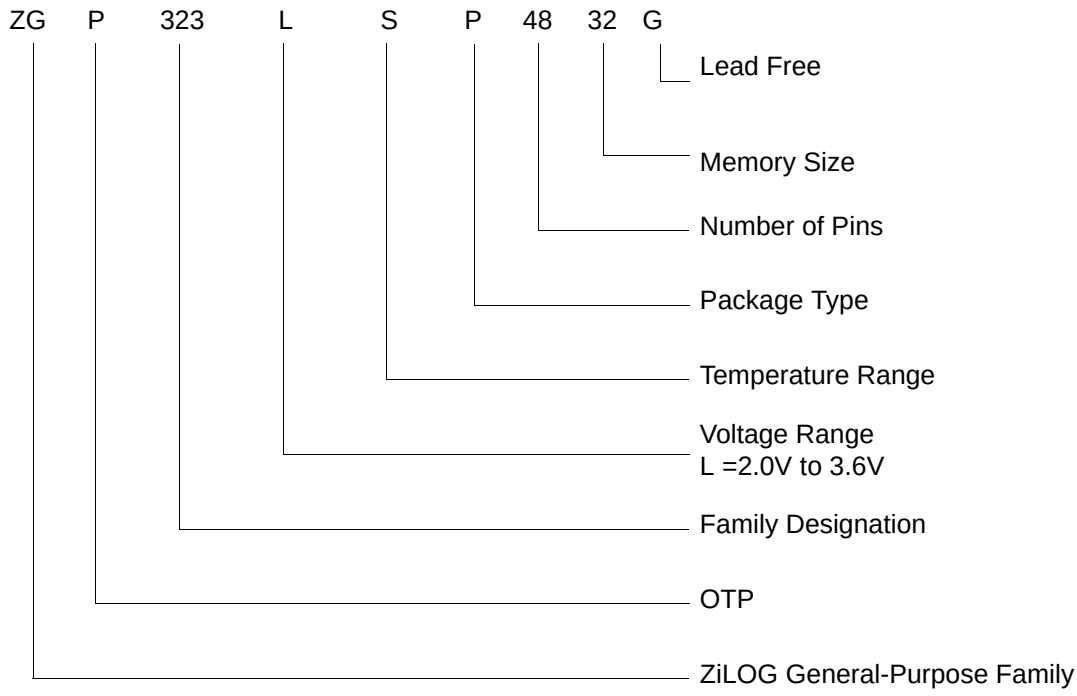
Figure 58. 20-Pin CDIP Package

16KB Standard Temperature: 0° to +70°C			
Part Number	**Description**	**Part Number**	**Description**
ZGP323LSH4816C	48-pin SSOP 16K OTP	ZGP323LSS2816C	28-pin SOIC 16K OTP
ZGP323LSP4016C	40-pin PDIP 16K OTP	ZGP323LSH2016C	20-pin SSOP 16K OTP
ZGP323LSH2816C	28-pin SSOP 16K OTP	ZGP323LSP2016C	20-pin PDIP 16K OTP
ZGP323LSP2816C	28-pin PDIP 16K OTP	ZGP323LSS2016C	20-pin SOIC 16K OTP

16KB Extended Temperature: -40° to +105°C			
Part Number	**Description**	**Part Number**	**Description**
ZGP323LEH4816C	48-pin SSOP 16K OTP	ZGP323LES2816C	28-pin SOIC 16K OTP
ZGP323LEP4016C	40-pin PDIP 16K OTP	ZGP323LES2016C	20-pin SOIC 16K OTP
ZGP323LEH2816C	28-pin SSOP 16K OTP	ZGP323LEH2016C	20-pin SSOP 16K OTP
ZGP323LEP2816C	28-pin PDIP 16K OTP	ZGP323LEP2016C	20-pin PDIP 16K OTP

16KB Automotive Temperature: -40° to +125°C			
Part Number	**Description**	**Part Number**	**Description**
ZGP323LAH4816C	48-pin SSOP 16K OTP	ZGP323LAS2816C	28-pin SOIC 16K OTP
ZGP323LAP4016C	40-pin PDIP 16K OTP	ZGP323LAH2016C	20-pin SSOP 16K OTP
ZGP323LAH2816C	28-pin SSOP 16K OTP	ZGP323LAP2016C	20-pin PDIP 16K OTP
ZGP323LAP2816C	28-pin PDIP 16K OTP	ZGP323LAS2016C	20-pin SOIC 16K OTP
Note: Replace C with G for Lead-Free Packaging			

Example


ZG
P
323
L
S
P
48
32
G
Lead Free
Memory Size
Number of Pins
Package Type
Temperature Range
Voltage Range
L =2.0V to 3.6V
Family Designation
OTP
ZiLOG General-Purpose Family

Precharacterization Product

The product represented by this document is newly introduced and ZiLOG has not completed the full characterization of the product. The document states what ZiLOG knows about this product at this time, but additional features or nonconformance with some aspects of the document might be found, either by ZiLOG or its customers in the course of further application and characterization work. In addition, ZiLOG cautions that delivery might be uncertain at times, due to start-up yield issues.

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